

## STGWT40HP65FB

## Trench gate field-stop IGBT, HB series 650 V, 40 A high speed

Datasheet - production data

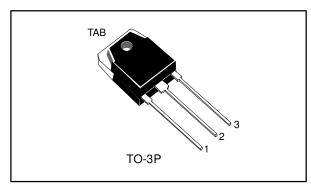
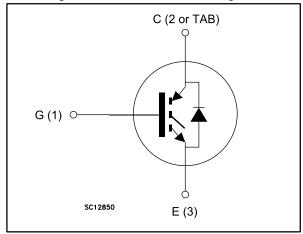


Figure 1: Internal schematic diagram



#### **Features**

- Maximum junction temperature: T<sub>J</sub> = 175 °C
- Minimized tail current
- $V_{CE(sat)} = 1.6 \text{ V (typ.)} @ I_C = 40 \text{ A}$
- Tight parameter distribution
- Co-packed diode for protection
- Safe paralleling
- Low thermal resistance

#### **Applications**

• Power factor corrector (PFC)

#### **Description**

This device is an IGBT developed using an advanced proprietary trench gate field-stop structure. The device is part of the new HB series of IGBTs, which represents an optimum compromise between conduction and switching loss to maximize the efficiency of any frequency converter. Furthermore, the slightly positive VCE(sat) temperature coefficient and very tight parameter distribution result in safer paralleling operation.

Table 1: Device summary

Order code	Marking	Package	Packing
STGWT40HP65FB	GWT40HP65FB	TO-3P	Tube

Contents STGWT40HP65FB

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STGWT40HP65FB Electrical ratings

# 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vces	Collector-emitter voltage (V <sub>GE</sub> = 0 V)	650	V
1-	Continuous collector current at T <sub>C</sub> = 25 °C	80	Α
lc	Continuous collector current at T <sub>C</sub> = 100 °C	40	A
ICP <sup>(1)</sup>	Pulsed collector current	160	Α
$V_{GE}$	Gate-emitter voltage	± 30	V
IF <sup>(2)</sup>	Continuous forward current at T <sub>C</sub> = 25 °C	5	Α
IF <sup>(-)</sup>	Continuous forward current at T <sub>C</sub> = 100 °C	5	A
I <sub>FP</sub> <sup>(3)</sup>	Pulsed forward current	10	Α
Ртот	Total dissipation at T <sub>C</sub> = 25 °C	283	W
Tstg	Storage temperature range	- 55 to 150	°C
TJ	Operating junction temperature range - 55 to 175		10

#### **Notes**

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R <sub>th</sub> JC	Thermal resistance junction-case IGBT	0.53	
$R_{thJC}$	Thermal resistance junction-case diode	5	°C/W
R <sub>thJA</sub>	Thermal resistance junction-ambient	50	

 $<sup>\</sup>ensuremath{^{(1)}}\mbox{Pulse}$  width limited by maximum junction temperature.

 $<sup>\</sup>ensuremath{^{(2)}}\textsc{Limited}$  by wires.

<sup>(3)</sup>Pulsed forward current.

## 2 Electrical characteristics

 $T_{\rm J} = 25~^{\circ}{\rm C}$  unless otherwise specified

**Table 4: Static characteristics** 

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)CES</sub>	Collector-emitter breakdown voltage	$V_{GE} = 0 \text{ V}, I_{C} = 2 \text{ mA}$	650			>
		$V_{GE} = 15 \text{ V}, I_{C} = 40 \text{ A}$		1.6	2.0	
V <sub>CE(sat)</sub>	V <sub>CE(sat)</sub> Collector-emitter saturation voltage	V <sub>GE</sub> = 15 V, I <sub>C</sub> = 40 A, T <sub>J</sub> = 125 °C		1.7		V
		V <sub>GE</sub> = 15 V, I <sub>C</sub> = 40 A, T <sub>J</sub> = 175 °C		1.8		
		I <sub>F</sub> = 5 A		2		
$V_{F}$	Forward on-voltage	I <sub>F</sub> = 5 A, T <sub>J</sub> = 125 °C		1.85		V
		I <sub>F</sub> = 5 A, T <sub>J</sub> = 175 °C		1.75		
$V_{\text{GE(th)}}$	Gate threshold voltage	$V_{CE} = V_{GE}, I_C = 1 \text{ mA}$	5	6	7	٧
I <sub>CES</sub>	Collector cut-off current	$V_{GE} = 0 \text{ V}, V_{CE} = 650 \text{ V}$			25	μΑ
I <sub>GES</sub>	Gate-emitter leakage current	$V_{CE} = 0 \text{ V}, V_{GE} = \pm 20 \text{ V}$			±250	nA

**Table 5: Dynamic characteristics** 

	,					
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Cies	Input capacitance		-	5412	1	
Coes	Output capacitance	$V_{CE} = 25 \text{ V, f} = 1 \text{ MHz,}$ $V_{GE} = 0 \text{ V}$	-	198	1	pF
Cres	Reverse transfer capacitance	VGE — V	-	107	1	
$Q_g$	Total gate charge	Vcc = 520 V, Ic = 40 A,	-	210	1	
$Q_{ge}$	Gate-emitter charge V <sub>GE</sub> = 15 V (see <i>Figure 29</i> :		-	39	ı	nC
Qgc	Gate-collector charge	"Gate charge test circuit")	-	82	-	

Table 6: IGBT switching characteristics (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(off)</sub>	Turn-off-delay time	V <sub>CE</sub> = 400 V, I <sub>C</sub> = 40 A,	1	142	1	ns
t <sub>f</sub>	Current fall time	$V_{GE} = 15 \text{ V}, R_G = 5 \Omega \text{ (see}$ Figure 28: "Test circuit for	-	27	-	ns
E <sub>off</sub> (1)	Turn-off switching energy	inductive load switching")	1	363	1	μЈ
$t_{d(off)}$	Turn-off-delay time	$V_{CE} = 400 \text{ V}, I_{C} = 40 \text{ A},$	-	141	-	ns
tf	Current fall time	$V_{GE} = 15 \text{ V}, R_{G} = 5 \Omega$ $T_{J} = 175 ^{\circ}\text{C} \text{ (see } Figure 28:)$	1	61	1	ns
E <sub>off</sub>	Turn-off switching energy	"Test circuit for inductive load switching")	-	764	-	μJ

#### Notes:

 $<sup>\</sup>ensuremath{^{(1)}}\xspace$  Including the tail of the collector current.

Table 7: Diode switching characteristics (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>rr</sub>	Reverse recovery time		-	140		ns
Qrr	Reverse recovery charge	$I_F = 5 A, V_R = 400 V,$	-	21		nC
I <sub>rrm</sub>	Reverse recovery current	V <sub>GE</sub> = 15 V (see <i>Figure</i> 28: "Test circuit for	-	6.6		Α
dl <sub>rr</sub> /dt	Peak rate of fall of reverse recovery current during t <sub>b</sub>	inductive load switching") di/dt = 1000 A/μs		430		A/μs
Err	Reverse recovery energy		-	1.6		μJ
trr	Reverse recovery time		-	200		ns
Q <sub>rr</sub>	Reverse recovery charge	I <sub>F</sub> = 5 A, V <sub>R</sub> = 400 V, V <sub>GE</sub> = 15 V T <sub>J</sub> = 175 °C	-	47.3		nC
I <sub>rrm</sub>	Reverse recovery current	(see Figure 28: "Test	-	9.6		Α
dl <sub>rr</sub> /dt	Peak rate of fall of reverse recovery current during t <sub>b</sub>	circuit for inductive load switching") di/dt = 1000 A/µs	-	428		A/μs
Err	Reverse recovery energy	α/αι = 1000 Α/μδ	-	3.2		μJ

## 2.1 Electrical characteristics (curves)

Figure 2: Power dissipation vs. case temperature

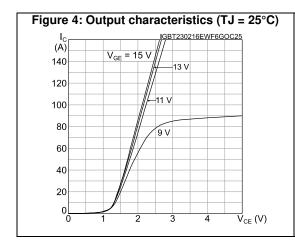
PTOT IGBT230216EWF6GPDT (W) VGE = 15 V, TJ ≤ 175 °C

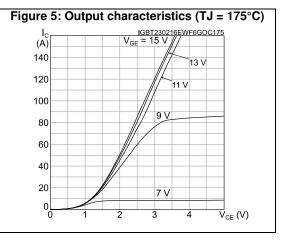
250

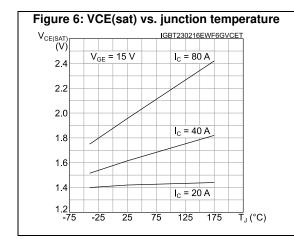
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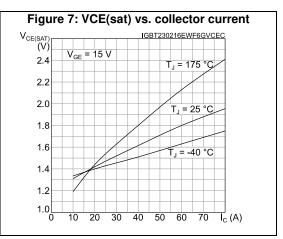
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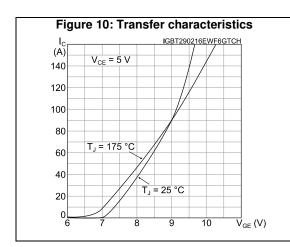
0 25 50 75 100 125 150 T<sub>C</sub> (°C)

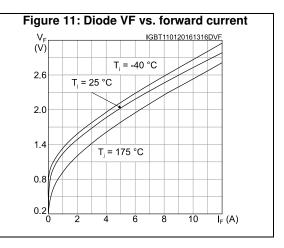


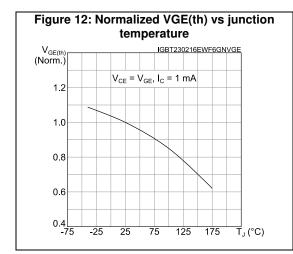












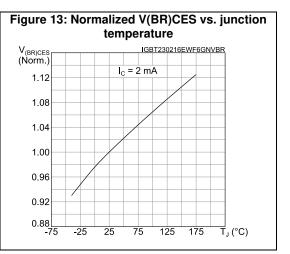
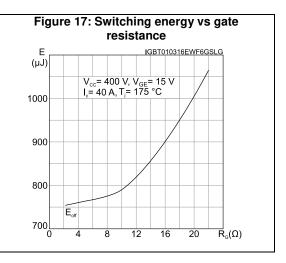
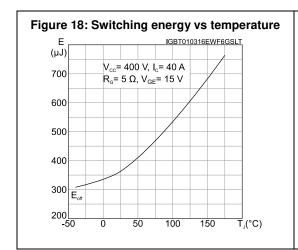


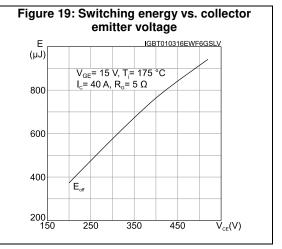
Figure 15: Gate charge vs. gate-emitter voltage

V<sub>GE</sub> | IGBT230216EWF6GGCGE |
(V) | V<sub>CC</sub> = 520 V, I<sub>C</sub> = 40 A |

15 | 10 | 5 |
0 | 40 | 80 | 120 | 160 | 200 | Q<sub>g</sub> (nC)







STGWT40HP65FB **Electrical characteristics** 

Figure 20: Switching times vs. collector current IGBT010316EWF6GSTC (ns) V<sub>cc</sub>= 400 V, V<sub>GE</sub>= 15 V R<sub>G</sub>= 5 Ω, T<sub>j</sub>= 175 °C 10<sup>2</sup> 10¹L 0

20

300

600

900

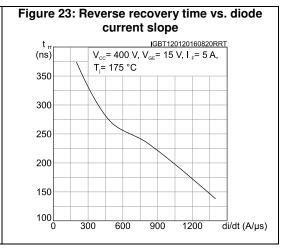
1200

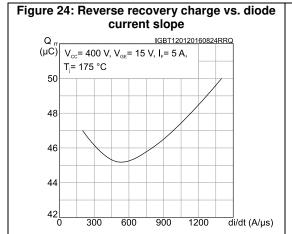
di/dt (A/µs)

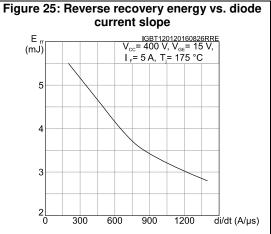
Figure 21: Switching times vs. gate resistance IGBT230216EWF6GSTR (ns) V<sub>CC</sub> = 400 V, V<sub>GE</sub> = 15 V I<sub>C</sub> = 40 A, T<sub>J</sub> = 175 °C  $t_{\text{d(off)}}$ 10<sup>2</sup> t<sub>f</sub> 10<sup>1</sup>  $\overline{R}_{G}(\Omega)$ 12 16 20

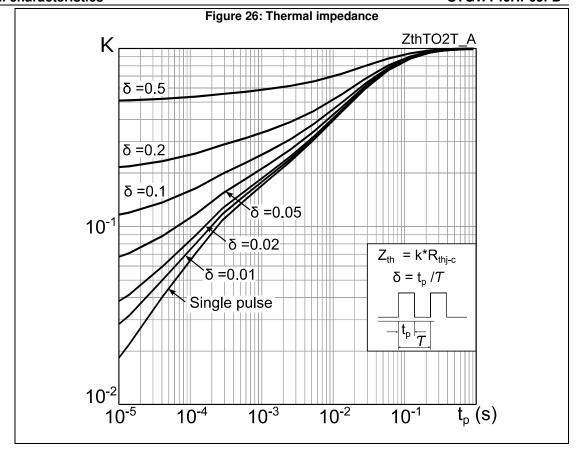
Figure 22: Reverse recovery current vs. diode current slope IGBT120120160800RRC (A) T<sub>J</sub>=175 °C 12 10 8

30 40 50 60 70 I<sub>C</sub>(A)

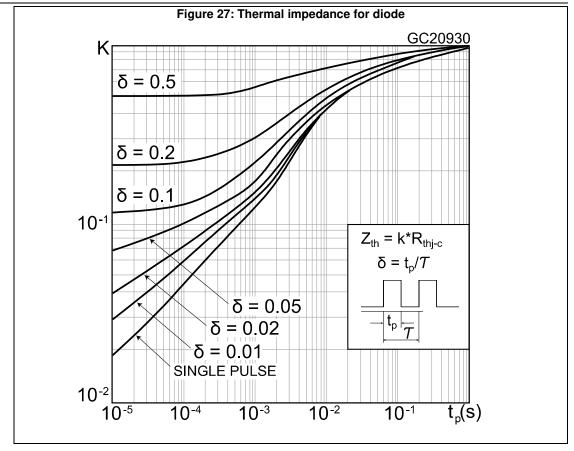






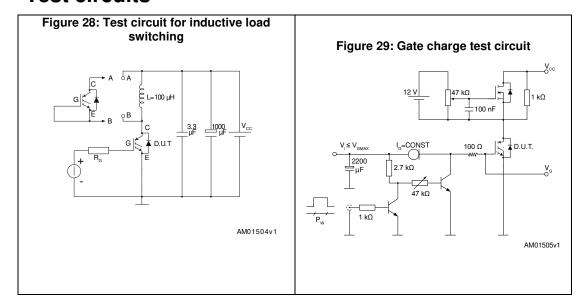


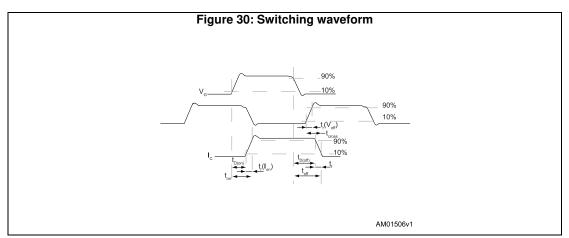
STGWT40HP65FB Electrical characteristics



Test circuits STGWT40HP65FB

## 3 Test circuits





STGWT40HP65FB Package information

## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

# 4.1 TO-3P package information

Figure 31: TO-3P package outline

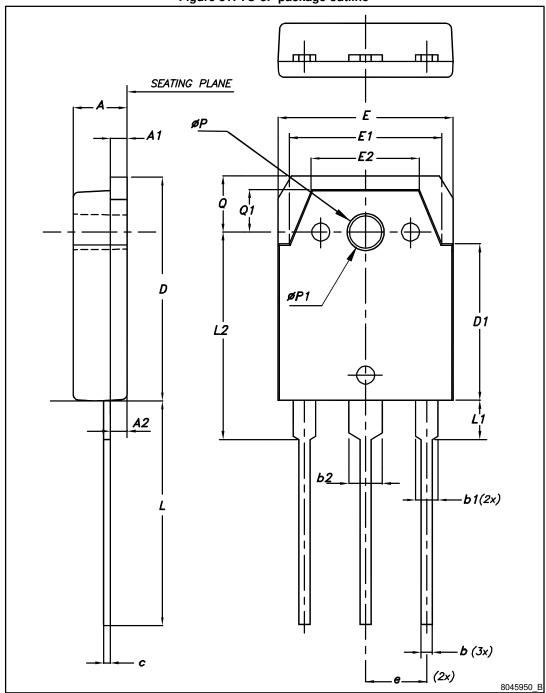


Table 8: TO-3P package mechanical data

Table 6. 10-51 package mechanical data					
Dim.		mm			
Dilli.	Min.	Тур.	Max.		
Α	4.60	4.80	5.00		
A1	1.45	1.50	1.65		
A2	1.20	1.40	1.60		
b	0.80	1.00	1.20		
b1	1.80	2.00	2.20		
b2	2.80	3.00	3.20		
С	0.55	0.60	0.75		
D	19.70	19.90	20.10		
D1	13.70	13.90	14.10		
Е	15.40	15.60	15.80		
E1	13.40	13.60	13.80		
E2	9.40	9.60	9.90		
е	5.15	5.45	5.75		
L	19.80	20.00	20.20		
L1	3.30	3.50	3.70		
L2	18.20	18.40	18.60		
ØP	3.30	3.40	3.50		
ØP1	3.10	3.20	3.30		
Q	4.80	5.00	5.20		
Q1	3.60	3.80	4		

Revision history STGWT40HP65FB

## 5 Revision history

**Table 9: Document revision history** 

Date	Revision	Changes
20-Oct-2015	1	First release.
01-Mar-2016	2	Updated features in cover page. Inserted Section 2.1: "Electrical characteristics (curves)". Minor text changes
13-Jul-2016	3	Document status promoted from preliminary to production data.

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